TOSHIBA Photocoupler GaAlAs IRed & Photo-Triac

# **TLP168J**

Triac Drive
Programmable Controllers
AC-Output Module
Solid State Relay

The TOSHIBA mini flat coupler TLP168J is a small outline coupler, suitable for surface mount assembly.

The TLP168J consists of a photo triac, optically coupled to a GaA $\ell$ As infrared emitting diode.

• Zero-voltage crossing turn-on

• Peak off-state voltage: 600 V (min.)

• Trigger LED current: 3 mA (max.)

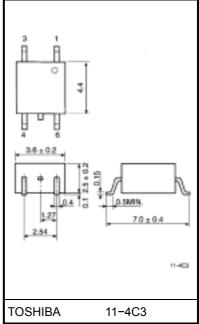
• On-state current: 70 mA (max.)

• Isolation voltage: 2500 Vrms (min.)

#### **Maximum Ratings (Ta = 25°C)**

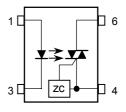
Characteristic			Symbol	Rating	Unit	
	Forward current		lF	20	mA	
	Forward current derating (Ta ≥ 25°C)		ΔI <sub>F</sub> / °C	-0.2	mA / °C	
LED	Peak forward current (100µs pulse, 100 pps)	I <sub>FP</sub>	1	А		
	Reverse voltage	V <sub>R</sub>	5	V		
	Junction temperature	Tj	125	°C		
	Off– state output terminal voltage		$V_{DRM}$	600	V	
	On-state RMS	Ta=25°C	I=	70	mA	
	current	Ta=70°C	I <sub>T(RMS)</sub>	40	IIIA	
Detector	On–state current derating (Ta ≥ 25°C)		ΔI <sub>T</sub> / °C	-0.67	mA / °C	
Det	Peak on–state current (100µs pulse, 120 pps)		I <sub>TP</sub>	2	А	
	Peak nonrepetitive surge current (PW=10ms, DC=10%)		I <sub>TSM</sub>	1.2	А	
	Junction temperature		Тj	115	°C	
Stora	age temperature range		T <sub>stg</sub>	-55~125	°C	
Oper	perating temperature range		T <sub>opr</sub>	-40~100	°C	
Lead	I soldering temperature (10s)		T <sub>sol</sub>	260	°C	
	Isolation voltage (AC, 1 min., R.H. ≤ 60%) (Note		BVS	2500	Vrms	

Unit in mm



Weight: 0.09 g

#### **Pin Configurations**



- 1: Anode
- 3: Cathode
- 4: Terminal 1
- 6: Terminal 2

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

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### **Recommended Operating Conditions**

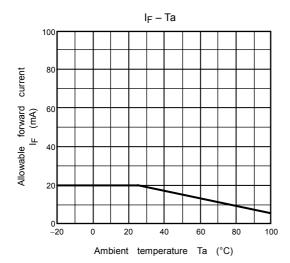
Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>AC</sub>	_	_	240	V <sub>ac</sub>
Forward current	lF	4.5	6	7.5	mA
Peak on-state current	ITP	1	1	1	Α
Operating temperature	$T_{opr}$	-10	-	85	°C

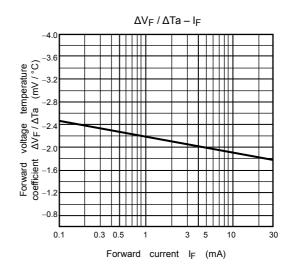
## Individual Electrical Characteristics (Ta = 25°C)

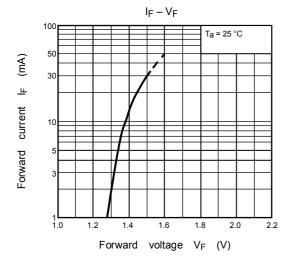
Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I <sub>F</sub> =10mA	1.2	1.4	1.7	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =3V	_	_	10	μA
	Capacitance	C <sub>T</sub>	V=0, f=1MHz	_	30	_	pF
Detector	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> =600V	_	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> =70mA	_	1.7	2.8	V
	Holding current	lΗ	_	_	0.6	_	mA
	Critical rate of rise of off– state voltage	dv / dt	V <sub>in</sub> =240Vrms, Ta=85°C	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> =60Vrms I <sub>T</sub> =15mArms	_	0.2	_	V / µs

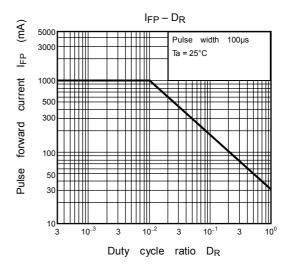
### **Coupled Electrical Characteristics (Ta = 25°C)**

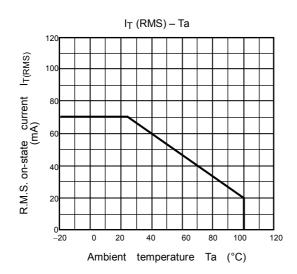
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> =6V	_	_	3	mA	
Inhibit voltage	V <sub>IH</sub>	I <sub>F</sub> =Rated I <sub>FT</sub>	_	_	50	V	
Leakage in inhibited state	lін	I <sub>F</sub> =Rated I <sub>FT</sub> V <sub>T</sub> = Rated V <sub>DRM</sub>	_	200	600	μΑ	
Capacitance (input to output)	Cs	V <sub>S</sub> =0, f=1MHz	_	0.8	_	pF	
Isolation resistance	Rs	V <sub>S</sub> =500V, R.H. ≤ 60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω	
	BVS	AC, 1 minute	2500	_	_	Vrms	
Isolation voltage		AC, 1 second, in oil	_	5000	_	VIIIIS	
		DC, 1 minute, in oil	_	5000	_	Vdc	

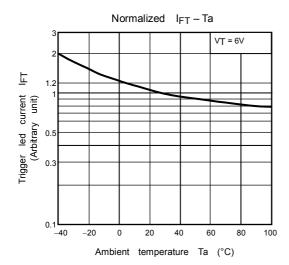


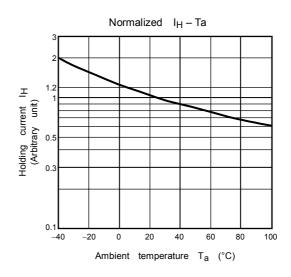


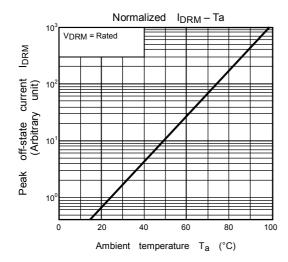


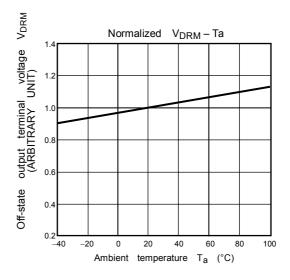


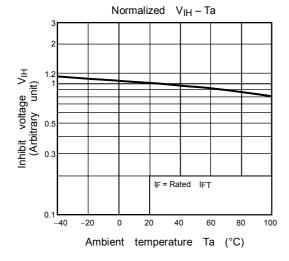


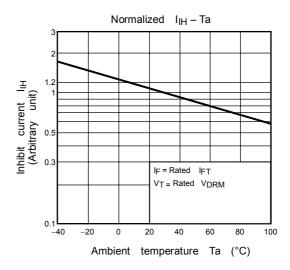












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